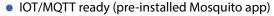
#### **Programmable Automation Controllers**

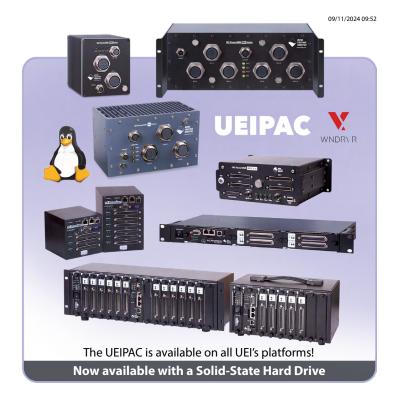
- Powerful stand-alone embedded controller
- Flexible, compact and rugged
- Standard Linux or VxWorks Operating System







- DDS support with ZeroMQ, OpenSplice or CoreDX
- EPICS CAS support included
- Web/HTML/HTML5 Web Socket interface support
- Flexible: Over >90 I/O boards available
- Solid-State Drive and/or SD Card-based storage
- 100Base-T, 100Base-FX (fiber), or Gigabit Ethernet
- Synchronization via IEEE-1588
- Xenomai or kernel-based real-time capability in Linux
- Ideal for HIL (Hardware In the Loop) applications



## **General Description:**

The UEIPAC offers an unprecedented combination of flexibility, high performance, low cost and small size. The unit is an ideal solution in a wide variety of measurement and control applications including: Temperature control, Remote/unmanned vehicle control, Hardware in-the-loop (HIL) and more. The UEIPAC is also an ideal solution for a host of embedded DAQ applications as it allows systems to be developed without the cost or the additional space required by an external host computer. The UEIPAC supports both VxWorks and Linux operating systems.

#### **Linux Systems**

- Uses standard 4.4.x Linux kernel with Xenomai 3.05 and Real-Time Linux 4.4.115 real-time support
- Program in standard C/C++
- Eclipse IDE support
- Develop on Linux PC or Windows PC in the Cygwin environment

#### **VxWorks Systems**

- Use your existing development license
- Obtain your run-time license from WindRiver
- Our BSP provides everything else you need including an assortment of helpful examples
- One-time charge for the BSP regardless of number of systems deployed

The UEIPAC is supported by all UEI DNA/DNR/DNF series chassis and uses the same I/O boards. There are currently over 90 different I/O boards available including analog input (with up to 24 bit resolution), analog output, digital I/O, MIL-STD-1553, ARINC 429/453/708, Serial and CAN communications, counter/timer, quadrature encoder input and more. With this many different I/O boards available, there is sure to be a configuration perfect for your application. A key advantage of

the UEIPAC is its standalone application deployment. In PowerDNA systems, the software application is written for, and runs on a host PC that is connected to one or more UEI chassis via Ethernet. In UEIPAC systems, the Linux/VxWorks application runs directly on the UEI RACK or Cube. There is no need for a separate host PC, though you can certainly connect one in a monitoring or supervisory role. This allows smaller, faster, more reliable and higher performance systems. It also eliminates the cost of a dedicated host PC and guarantees long term availability of the identical hardware. This is critical when certifying products through CE or FDA, etc.

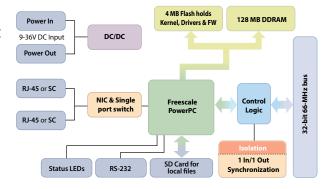
The heart of every UEIPAC is a 5200 or 8347 PowerPC processor

running a standard VxWorks or Linux OS. An 8347E version is available for applications requiring encryption. Flash memory contains the OS Kernel and drivers for each of the I/O boards. The CPU board also provides an SD Card slot, Ethernet interface, Intercube trigger/sync interface, RS-232 serial port as well as the power supply inputs and a variety of annunciator LEDs. Optional 8, 16, & 32 GByte solidstate hard are also available on GigE based units. The file system which is contained on the SD card or SSD (GigE only), includes the other components of the operating system such as libraries, utilities, init script and

daemons. The GigE Cubes and RACKS provide a USB 2.0 port usable with external hard drives or memory sticks. Synchronization is possible via sync connector or IEEE-1588.

The GigE Cubes and RACKs provide dual Ethernet ports, each of which resides at a unique IP address. These are most commonly used to provide separate primary control and diagnostic ports but can also function as teamed/bonded redundant interfaces.

## Hardware Block Diagram: (UEIPAC 300/600)



<sup>\*</sup> No SD and uSD available for MIL and BRICK chassis.

### **Linux Programming**

Your application runs as a regular Linux process giving you access to the standard POSIX API provided by the GNU C runtime library (glibc) as well as any other library that can be compiled for Linux (for example: libxml, libaudio file...).

The UEIPAC includes an EPICS (Experimental Physics and Industrial Control System) Channel Access Server (CAS). The LibSharedData software allows easy connection of the UEIPAC to HTML/HTML5 browsers via Web Sockets or other PCs via TCP/IP Sockets.

Whether your application requires a few I/O channels or a few thousand, the UEIPAC is an ideal solution. The UEIPAC's unique combination of Linux operating system, real-time support, I/O flexibility, compact size, mechanical and electrical ruggedness, and ease of use is unparalleled.

## **UEIPAC Linux TK Programmer's Toolkit**

The programmer's toolkit provides the software tools necessary to create an embedded application targeting Linux on the UEIPAC's PowerPC processor. This includes most popular versions of Linux such as Fedora and Suse. The development environment runs on a Linux PC or in the Cygwin environment on a Windows PC. The UEIPAC is also supported by the popular Eclipse IDE. Applications requiring hard real-time functionality are possible using the Xenomai 3.05 Linux extension or the Real-Time Linux capability included in the 4.4.115 series kernel. The RT Linux kernel must be used for proper IEEE-1588 performance.

The UEIPAC development environment includes:

- GCC 6.3.0 based cross-compiler for applications targeting the UEIPAC PPC module
- · GNU toolchain tools such as make
- · Standard Linux libraries such as glibc
- · UEIPAC library for the various I/O boards/devices

The UEIPAC Linux TK is not included with the UEIPAC and must be purchased as a separate item. Only one Linux toolkit must be purchased, regardless of the number of UEIPAC deployed.

The toolkit uses the same API as our popular PowerDNA Cubes, allowing you to reuse existing programs that were designed to run with a PowerDNA Cube over the network. This allows you to develop your application on your desktop, working directly with a "slaved" PowerDNA Cube. Once you are satisfied with your system, you may port the programs to run directly on the UEIPAC Cube with few modifications.

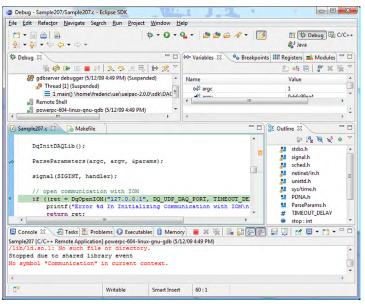
After the UEIPAC power-up, you have a ready to go Linux OS with FTP and web servers as well as a command line shell accessible from the serial port or telnet and SSH over the network.

#### **EPICS:**

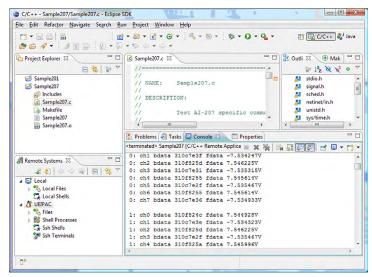
(Experimental Physics and Industrial Control System) is popular standard in high-energy physics laboratories. Our new EPICS server provides the source code to set up the UEIPAC as an EPICS CAS (Channel Access Server), allowing you to configure any I/O input or output as a PV (Process Variable).

## **Eclipse IDE support**

The UEIPAC is now supported by the Eclipse IDE. Programmers may now take advantage of the many powerful Eclipse tools to build their UEIPAC applications.



The Eclipse IDE debug screen.



A typical Eclipse IDE run-time screen.

## **New Software Support**

#### **Web Browser Interface**

Our new LibSharedData API/library allows easy connection of the UEIPAC to HTML/HTML5 browsers via Web Sockets or other PCs via TCP/IP Sockets. The HTML5 interface is fully compatible with many "mobile" browsers including Safari for iOS and iPhones and iPads and the Android web browser. Of course the standard HTML interface is provided to interface to more general purpose web browsers.

#### IOT

The UEIPAC comes with Mosquitto pre-installed. Mosquito implements a broker and a C library to publish/subscribe MQTT messages. Examples and API documentation can be found at http://mosquito.org. UEIPAC comes with the SampleDMAP\_MQTT example that can acquire and publish data from AI, DI or counter/timer layers. The example can also subscribe to external data and write it on AO and DO outputs.

## **VxWorks Programming**

You may now take advantage of all the hardware advantages of UEI's popular UEIPAC chassis and continue to develop your applications in VxWorks. This powerful combination provides hard real-time performance, an extremely robust and reliable operating system, allows you to develop your application in a familiar environment and last, but not least, allows you to preserve a great deal of previously written code! To deploy a UEIPAC application running VxWorks you'll need the following.

- 1. A UEIPAC\* (any version with GigE Ethernet ports)
- 2. The "UEIPAC VxW BSP". You only need to purchase the BSP once, regardless of the number of systems you deploy
- 3. A VxWorks v 6.9.x development system (from Wind River)
- 4. A VxWorks run-time license for each UEIPAC deployed (also purchased from Wind River)

Though it's beyond the scope of the datasheet to provide details on how to configure and program the UEIPAC in VxWorks, the following is the table of contents from the current revision of the VxWorks UEIPAC user manual. The steps mentioned should be familiar to existing VxWorks programmers and should help the reader understand the process.

#### 1 Configuring and building a VxWorks kernel for UEIPAC

- 1.1 Installing Software
- 1.1.1 Extract files
- 1.1.2 Build PowerDNA driver
- 1.2 Building a VxWorks kernel for UEIPAC
- 1.2.1 Create a VxWorks Image Project
- 1.2.2 Kernel Configuration
- 1.2.3 Build Kernel
- 1.3 Booting VxWorks kernel on UEIPAC
- 1.3.1 Manual boot
- 1.3.2 Store kernel in flash
- 1.3.3 Automatic boot in VxWorks

#### 2 Programming with PowerDNA API

- 2.1 Building PowerDNA library
- 2.1.1 Set-up environment
- 2.1.2 Install PowerDNA driver source and documentation
- 2.1.3 Build library using DIAB tools
- 2.1.4 Build library using GNU tools
- 2.2 Building an example as a kernel module
- 2.2.1 Creating workbench project
- 2.2.2 Running the example
- 2.2.3 Debugging the example
- \*UEIPAC CPU option 03 is not currently supported by VxWorks. Please contact UEI if your application requires VxWorks support on an "03" version of the CPU.

## **UEIPAC: Technical Specifications**

Configuration Peter Port 10/100/1000Base-T, 38999 connector  Net Teaming/Bonding Supported in both Linux and VxWorks deployments  Configuration/Serial Port on LAN/COM 38999 connector  USB Port USB 2.0 fully supported  Sync input/output port or IEEE-1588 (requires use of RT Linux 4.4.115 kernel)  I/O Board Support  Series supported All DNR/DNA-series boards as appropriate  Software / Operating System  Embedded OS Linux, kernel 44.71 or VxWorks 6.9 x  Real-time support Xenomal 3.05 or 4.4.115 kernel based Real-time Linux, VxWorks is a real-time OS  EPICS CAS interface Yes (Linux version)  SNMP Library Yes  Processor/system  CPU Freescale 8347 or 8347E, 400 MHz, 32-bit  Memory 256 MB, 228 MB available to user applications  Solid-State Hard Drive Optional 16 MB/112 MB available for user applications  Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available  USB drive interface Standard USB 2.0 port  Physical Dimensions  41/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  12/O slots UEIPAC 400-MIL: 11.6" W x 6.4" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating)  UEIPAC 1200-MIL  Temperature (operating)  UEIPAC 400-MIL  Temperature (operating)  UEIPAC 400-MIL  Temperature (operating)  UEIPAC 400-MIL  Temperature (operating)  UEIPAC 400-MIL  Temperature (operating)  UEIPAC 100-MIL  Temperature (operatin	Computer Interface	MU sovies ruggedized shassis				
Diagnostic Port  Net Teaming/Bonding Supported in both Linux and VxWorks deployments  Configuration/Serial Port  USB 2.0 fully supported Synchronization Options Series support  All DNR/DNA-series boards as appropriate  Software / Operating System Software / Operating System Software / Operating System Senetary - Operating System Senetary - Operating System Self-CS CAS interface Yes (Linux version) SNMP Library Yes  Processor/system CPU Freescale 8347 or 8347E, 400 MHz, 32-bit Memory Senetary - Operating System Solid-State Hard Drive Synchronization Optional Solid-State Hard Drive Optional 8, 16, or 32 Gbyte drives available Solid-State Hard Drive Optional 8, 16, or 32 Gbyte drives available Standard USB 2.0 port Physical Dimensions  4/O slots UEIPAC 400-MIL: 10, W x 6,4" D x 7,0" H, 16 lbs. UEIPAC 1200-MIL: 11,5" W x 8,1" D x 7,0" H, 16 lbs. UEIPAC 1200-MIL: 17,5" W x 8,125" D x 7,0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL Temperature (operating) UEIPAC 120	Computer Interface	MIL series ruggedized chassis				
Net Teaming/Bonding Configuration/Serial Port on LAN/COM 38999 connector USB Port USB 2.0 fully supported Synchronization Options Syncinput/output port or IEEE-1588 (requires use of RT Linux 4.4.115 kernel)  I/O Board Support Series supported All DNR/DNA-series boards as appropriate  Software / Operating System Embedded OS Linux, kernel 4.4.71 or VxWorks 6.9.x Real-time support Xenomai 3.05 or 4.4.115 kernel based Real-time binux, vxWorks is a real-time OS  EPICS CAS interface Yes (Linux version)  SNMP Library Yes  Processor/system  CPU Freescale 8347 or 8347E, 400 MHz, 32-bit Memory 256 MB, 228 MB available to user applications  16 MB/112 MB available for user applications  Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available USB drive interface Standard USB 2.0 port  Physical Dimensions  41/O slots UEIPAC 400-MIL: 6.2" Wx 8.7" Dx 7.1" H, 11 lbs.  61/O slots UEIPAC 400-MIL: 11.6" Wx 8.7" Dx 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIP	•	,				
deployments  Configuration/Serial Port USB 2.0 fully supported  Synchronization Options Sync input/output port or IEEE-1588 (requires use of RT Linux 4.4.115 kernel)  I/O Board Support  Series supported All DNR/DNA-series boards as appropriate  Software / Operating System  Embedded OS Linux, kernel 4.4.71 or VxWorks 6.9.x  Real-time support Xenomai 3.05 or 4.4.115 kernel based Real-time Linux, VxWorks is a real-time OS  EPICS CAS interface Yes (Linux version)  SNMP Library Yes  Processor/system  CPU Freescale 8347 or 8347E, 400 MHz, 32-bit  Memory 256 MB, 228 MB available to user applications  FLASH memory 32 MB standard/128 MB optional  16 MB/112 MB available for user applications  Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available  USB drive interface Standard USB 2.0 port  Physical Dimensions  41/O slots UEIPAC 400-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs.  12 I/O slots UEIPAC 600-MIL: 11.6" W x 8.7" D x 7.0" H, 16 lbs.  12 I/O slots UEIPAC 600-MIL: 11.6" W x 8.7" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) 40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (operating) 40 °C to 70 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (operating) 40 °C to 70 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (operating) 40 °C to 70 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage) 40 °C to 85 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64) 10-500 Hz, 5 g, Sinusoidal  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Default unit sealed to 1P 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours	Diagnostic Port	10/100/1000Base-T, 38999 connector				
USB Port  Synchronization Options  Synchronization Options  Sync input/output port or IEEE-1588 (requires use of RT Linux 4.4.115 kernel)  I/O Board Support  Series supported  All DNR/DNA-series boards as appropriate  Software / Operating System  Embedded OS  Real-time support  Xenomai 3.05 or 4.4.115 kernel based Real-time Linux, VxWorks 6.9.x  Real-time support  Xenomai 3.05 or 4.4.115 kernel based Real-time Linux, VxWorks is a real-time OS  EPICS CAS interface  Yes (Linux version)  SNMP Library  Yes  Processor/system  CPU  Freescale 8347 or 8347E, 400 MHz, 32-bit  Memory  256 MB, 228 MB available to user applications  16 MB/112 MB available for user applications  Solid-State Hard Drive  Optional 8, 16, or 32 GByte drives available  USB drive interface  Standard USB 2.0 port  Physical Dimensions  41/O slots  UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  12 I/O slots  UEIPAC 1200-MIL: 11.6" W x 6.4" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating)  UEIPAC 1200-MIL  Temperature (operating)  UEIPAC 200-MIL  Temperature (operating)  UEIPAC 400-MIL  Temperature (operating)  UEIPAC 400-MIL  Temperature (storage)  40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage)  40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage)  40 °C to 85 °C  Humidity  0 to 95%, non-condensing  Vibration  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64)  10-500 Hz, 5 g, Sinusoidal  Shock  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64)  10-500 Hz, 5 g (rms), Broad-band random  (IEC 60068-2-67)  100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at	Net Teaming/Bonding					
Synchronization Options Sync input/output port or IEEE-1588 (requires use of RT Linux 4.4.115 kernel)  I/O Board Support  Series supported All DNR/DNA-series boards as appropriate  Software / Operating System  Embedded OS Linux, kernel 4.4.71 or VxWorks 6.9.x  Real-time support Real-time Linux, VxWorks is a real-time OS  EPICS CAS interface Yes (Linux version)  SNMP Library Yes  Processor/system  CPU Freescale 8347 or 8347E, 400 MHz, 32-bit Memory 256 MB, 228 MB available to user applications  Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available  USB drive interface Standard USB 2.0 port  Physical Dimensions  4 I/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  6 I/O slots UEIPAC 400-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs.  12 I/O slots UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 100-MIL: 10.8" C 85"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 85"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 85"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 85"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 85"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 85"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 70"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 70"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 70"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 70"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 70"C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 70"C (power dissipation of actual syste	Configuration/Serial Port	on LAN/COM 38999 connector				
(requires use of RT Linux 4.4.115 kernel)  I/O Board Support  Series supported All DNR/DNA-series boards as appropriate  Software / Operating System  Embedded OS Linux, kernel 4.4.71 or VxWorks 6.9.x  Real-time support Xenomai 3.05 or 4.4.115 kernel based Real-time Linux, VxWorks is a real-time OS  EPICS CAS interface Yes (Linux version)  SNMP Library Yes  Processor/system  CPU Freescale 8347 or 8347E, 400 MHz, 32-bit Memory 256 MB, 228 MB available to user applications  FLASH memory 32 MB standard/128 MB optional 16 MB/112 MB available for user applications  Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available  USB drive interface Standard USB 2.0 port  Physical Dimensions  41/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  61/O slots UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs.  12 I/O slots UEIPAC 600-MIL: 11.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) 40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  ### Colorable Colo-Mil  Temperature (operating) UEIPAC 600-Mil  Temperature (operating) 40 °C to 70"C (power dissipation of actual system may require derated maximum temperature)  ### Colorable Colo-Mil  Temperature (storage) 40 °C to 85 °C  Humidity 0 to 95%, non-condensing  Wibration MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64) 10-500 Hz, 5 g, Sinusoidal  Shock MIL-STD-810G plus the IEC specs below  (IEC 60068-2-67) 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations was provided to 19 6 or bette	USB Port	USB 2.0 fully supported				
Series supported All DNR/DNA-series boards as appropriate  Software / Operating System  Embedded OS Linux, kernel 4.4.71 or VxWorks 6.9.x  Real-time support Xenomai 3.05 or 4.4.115 kernel based Real-time Linux, VxWorks is a real-time OS  EPICS CAS interface Yes (Linux version)  SNMP Library Yes  Processor/system  CPU Freescale 8347 or 8347E, 400 MHz, 32-bit  Memory 256 MB, 228 MB available to user applications  FLASH memory 32 MB standard/128 MB optional 16 MB/112 MB available for user applications  Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available  Standard USB 2.0 port  Physical Dimensions  4 I/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  6 I/O slots UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs.  12 I/O slots UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating)  UEIPAC 600-MIL may require derated maximum temperature)  Temperature (operating)  UEIPAC 400-MIL may require derated maximum temperature)  Temperature (operating)  UEIPAC 400-MIL may require derated maximum temperature)  Temperature (storage) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (operating) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (operating) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (operating) -40 °C to 85 °C	Synchronization Options					
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Real-time support  Xenomai 3.05 or 4.4.115 kernel based Real-time Linux, VxWorks is a real-time OS  EPICS CAS interface  Yes (Linux version)  Yes  Processor/system  CPU  Freescale 8347 or 8347E, 400 MHz, 32-bit  Memory  256 MB, 228 MB available to user applications  FLASH memory  32 MB standard/128 MB optional 16 MB/112 MB available for user applications  Solid-State Hard Drive  USB drive interface  Standard USB 2.0 port  Physical Dimensions  4 I/O slots  UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  6 I/O slots  UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs.  12 I/O slots  UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 900-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 900-MIL  100 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	Software / Operating Syst	em				
Real-time Linux, VxWorks is a real-time OS  FPICS CAS interface Yes (Linux version)  Froessor/system  CPU Freescale 8347 or 8347E, 400 MHz, 32-bit  Memory 256 MB, 228 MB available to user applications  FLASH memory 32 MB standard/128 MB optional 16 MB/112 MB available for user applications  Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available USB drive interface Standard USB 2.0 port  Physical Dimensions  4 I/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  12 I/O slots UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs.  12 I/O slots UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 400-MIL Temperature (operating) UEIPAC 400-MIL Temperature (operating) UEIPAC 400-MIL Temperature (operating) UEIPAC 400-MIL Temperature (operating) UEIPAC 500-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 100-MIL Temper	Embedded OS	Linux, kernel 4.4.71 or VxWorks 6.9.x				
Processor/system  CPU Freescale 8347 or 8347E, 400 MHz, 32-bit  Memory 256 MB, 228 MB available to user applications  FLASH memory 32 MB standard/128 MB optional 16 MB/112 MB available for user applications  Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available  USB drive interface Standard USB 2.0 port  Physical Dimensions  4 I/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  6 I/O slots UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs.  12 I/O slots UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 600-MIL unay require derated maximum temperature)  Temperature (operating) UEIPAC 600-MIL unay require derated maximum temperature)  Temperature (operating) UEIPAC 600-MIL unay require derated maximum temperature)  Temperature (operating) UEIPAC 400-MIL unay require derated maximum temperature)  Temperature (operating) UEIPAC 600-MIL unay require derated maximum temperature)  Temperature (operating) UEIPAC 400-MIL unay require derated maximum temperature)  Temperature (operating) UEIPAC 600-MIL unay require derated maximum temperature)  Temperature (operating) UEIPAC 600-MIL unay require derated maximum temperature)  Temperature (operating) UEIPAC 600-MIL unay require derated maximum temperature)  Temperature (operating) unay require derated maximum temperature)  Temperature (operati	Real-time support					
Processor/system  CPU Freescale 8347 or 8347E, 400 MHz, 32-bit  Memory 256 MB, 228 MB available to user applications  FLASH memory 32 MB standard/128 MB optional 16 MB/112 MB available for user applications  Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available  USB drive interface Standard USB 2.0 port  Physical Dimensions  4 I/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  6 I/O slots UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs.  12 I/O slots UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 600-MIL unay require derated maximum temperature)  Temperature (operating) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (operating) uEIPAC 400-MIL unay require derated maximum temperature)  Temperature (storage) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage) -40 °C to 85 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810G plus the IEC specs below  (IEC 60068-2-6) 10-500 Hz, 5 g (rms), Broad-band random  (IEC 60068-2-6) 10-500 Hz, 5 g, Sinusoidal  Shock MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27) 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 -36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours	EPICS CAS interface	Yes (Linux version)				
CPU Freescale 8347 or 8347E, 400 MHz, 32-bit  Memory 256 MB, 228 MB available to user applications  FLASH memory 32 MB standard/128 MB optional 16 MB/112 MB available for user applications  Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available  USB drive interface Standard USB 2.0 port  Physical Dimensions  41/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  61/O slots UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs.  121/O slots UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL available of a citual system may require derated maximum temperature)  Temperature (operating) UEIPAC 600-MIL available of a citual system may require derated maximum temperature)  Temperature (operating) UEIPAC 400-MIL available of a citual system may require derated maximum temperature)  Temperature (storage) -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage) -40 °C to 85 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64) 10-500 Hz, 5 g, Sinusoidal  Shock MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27) 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours	SNMP Library	Yes				
Memory PLASH memory 32 MB standard/128 MB optional 16 MB/112 MB available for user applications Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available USB drive interface Standard USB 2.0 port Physical Dimensions 4 I/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs. 6 I/O slots UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs. 12 I/O slots UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs. Environmental Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 400-MIL Temperature (operating) UEIPAC 600-MIL Temperature (op	Processor/system					
FLASH memory  32 MB standard/128 MB optional 16 MB/112 MB available for user applications  Solid-State Hard Drive  Optional 8, 16, or 32 GByte drives available  USB drive interface  Standard USB 2.0 port  Physical Dimensions  4 I/O slots  UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs.  6 I/O slots  UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs.  12 I/O slots  UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (storage)  40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage)  40 °C to 70 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage)  40 °C to 85 °C  Humidity  0 to 95%, non-condensing  Vibration  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64)  10-500 Hz, 5 g, Sinusoidal  Shock  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27)  100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI  Designed to meet MIL-STD-461  Altitude  70,000 feet, maximum  Sealing  Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage  9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL  >100,000 hours	CPU	Freescale 8347 or 8347E, 400 MHz, 32-bit				
Solid-State Hard Drive Optional 8, 16, or 32 GByte drives available USB drive interface Standard USB 2.0 port  Physical Dimensions 4 I/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs. 6 I/O slots UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs. 12 I/O slots UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL may require derated maximum temperature)  -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (operating) UEIPAC 400-MIL may require derated maximum temperature)  -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 70 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (operating) UEIPAC 400-MIL may require derated maximum temperature)  -40 °C to 85 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64) 10–500 Hz, 5 g (rms), Broad-band random  (IEC 60068-2-64) 10–500 Hz, 5 g, Sinusoidal  Shock MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27) 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL > 100,000 hours  MTBF 600-MIL > 100,000 hours	Memory	256 MB, 228 MB available to user applications				
Solid-State Hard Drive  USB drive interface  Physical Dimensions  4 I/O slots  UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs. 6 I/O slots  UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs. 12 I/O slots  UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 1200-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 100-MIL  Temperature (operating) UEIPAC 100-MIL  Temperature (operating) UEIPAC 100-MIL  Temperature (operating) UEIPAC 90-MIL  Temperature (operating) UEIPAC 100-MIL  Temperature (operating) UEIPAC 100-MIL  Temperature (operating) UEIPAC 100-MIL  Temperature (operating) UEIPAC 100-MIL  Temperature (operating) UEIPAC 600-MIL  To °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 70°C (power dissipation of actual system may require derated maximum temperature)  100 95%, non-condensing  Vibration  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64)  10-500 Hz, 5 g, Sinusoidal  Shock  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27)  100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI  Designed to meet MIL-STD-461  Altitude  70,000 feet, maximum  Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage  9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL  >100,000 hours	FLASH memory					
USB drive interface  Physical Dimensions  4 I/O slots  UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs. 6 I/O slots  UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs. 12 I/O slots  UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (storage)  -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature)  Temperature (storage)  -40 °C to 85 °C  Humidity  0 to 95%, non-condensing  Vibration  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64)  10-500 Hz, 5 g, Sinusoidal  Shock  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27)  100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI  Designed to meet MIL-STD-461  Altitude  70,000 feet, maximum  Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage  9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL  NTBF 600-MIL  >100,000 hours						
Physical Dimensions 4 I/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs. 6 I/O slots UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs. 12 I/O slots UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 400-MIL Temperature (operating) UEIPAC 400-MIL Temperature (storage) UEIPAC 400-MIL Temperature (storage) UEIPAC 400-MIL Temperature (storage) UEIPAC 400-MIL Temperature (storage) UEIPAC 500-MIL Temperature (storage) UEIPAC 600-MIL Temperature (storage) UEIPAC 1200-MIL Temperature derated maximum temperature) UEIPAC 1200-MIL Temperature (storage) UEIPAC 1200-MIL Temperature derated maximum temperature) UEIPAC (power dissipation of actual system underated max		•				
4 I/O slots UEIPAC 400-MIL: 6.2" W x 8.7" D x 7.1" H, 11 lbs. 6 I/O slots UEIPAC 600-MIL: 11.6" W x 6.4" D x 7.0" H, 16 lbs. 12 I/O slots UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.  Environmental  Temperature (operating) UEIPAC 1200-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 600-MIL Temperature (operating) UEIPAC 400-MIL Temperature (operating) UEIPAC 400-MIL Temperature (storage) UEIPAC 500-MIL Temperature (storage) UEIPAC 600-MIL Temperature (storage) UEIPAC 600-MIL Temperature (storage) UEIPAC 1200-MIL Temperature (operating) UEIPAC 1200-MIL Temperature dissipation of actual system may require derated maximum temperature) UEIPAC 1200-MIL Temperature (operating) UEIPAC 1200-MIL Temperature (operation) Temperature (operation) Temperature (operation) Temperature (operation) Temperature (operation) Temperature (operat		Standard USB 2.0 port				
Comparison of the comparison						
UEIPAC 1200-MIL: 17.5" W x 8.125" D x 7.0" H, 22 lbs.		·				
Ibs.						
Temperature (operating) UEIPAC 1200-MIL  Temperature (operating) UEIPAC 600-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (operating) UEIPAC 400-MIL  Temperature (storage)  Humidity  Vibration  (IEC 60068-2-64)  Shock  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-6)  Shock  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27)  100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI  Designed to meet MIL-STD-461  Altitude  Sealing  Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage  9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL  >100,000 hours	12 I/O slots	· ·				
UEIPAC 1200-MILmay require derated maximum temperature)Temperature (operating) UEIPAC 600-MIL-40 °C to 85°C (power dissipation of actual system may require derated maximum temperature)Temperature (operating) UEIPAC 400-MIL-40 °C to 70°C (power dissipation of actual system may require derated maximum temperature)Temperature (storage)-40 °C to 85 °CHumidity0 to 95%, non-condensingVibrationMIL-STD-810G plus the IEC specs below(IEC 60068-2-64)10-500 Hz, 5 g (rms), Broad-band random(IEC 60068-2-6)10-500 Hz, 5 g, SinusoidalShockMIL-STD-810G plus the IEC specs below(IEC 60068-2-27)100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientationsEMI / RFIDesigned to meet MIL-STD-461Altitude70,000 feet, maximumSealingDefault unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.Power Requirements9 - 36 VDC designed to meet MIL-1275/704Notage9 - 36 VDC designed to meet MIL-1275/704MTBF 400-MIL>100,000 hours	Environmental					
UEIPAC 600-MIL may require derated maximum temperature)  Temperature (operating) UEIPAC 400-MIL may require derated maximum temperature)  -40 °C to 70 °C (power dissipation of actual system may require derated maximum temperature)  -40 °C to 85 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64) 10–500 Hz, 5 g (rms), Broad-band random  (IEC 60068-2-6) 10–500 Hz, 5 g, Sinusoidal  Shock MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27) 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours						
UEIPAC 400-MIL       may require derated maximum temperature)         Temperature (storage)       -40 °C to 85 °C         Humidity       0 to 95%, non-condensing         Vibration       MIL-STD-810G plus the IEC specs below         (IEC 60068-2-64)       10-500 Hz, 5 g (rms), Broad-band random         (IEC 60068-2-6)       10-500 Hz, 5 g, Sinusoidal         Shock       MIL-STD-810G plus the IEC specs below         (IEC 60068-2-27)       100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations         EMI / RFI       Designed to meet MIL-STD-461         Altitude       70,000 feet, maximum         Sealing       Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.         Power Requirements         Voltage       9 - 36 VDC designed to meet MIL-1275/704         Reliability       NTBF 400-MIL       >100,000 hours         MTBF       600-MIL       >100,000 hours		,				
Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64) 10–500 Hz, 5 g (rms), Broad-band random  (IEC 60068-2-6) 10–500 Hz, 5 g, Sinusoidal  Shock MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27) 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours		· · · · · · · · · · · · · · · · · · ·				
Vibration MIL-STD-810G plus the IEC specs below  (IEC 60068-2-64) 10–500 Hz, 5 g (rms), Broad-band random  (IEC 60068-2-6) 10–500 Hz, 5 g, Sinusoidal  Shock MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27) 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours	Temperature (storage)	-40 °C to 85 °C				
(IEC 60068-2-64) 10–500 Hz, 5 g (rms), Broad-band random (IEC 60068-2-6) 10–500 Hz, 5 g, Sinusoidal  Shock MIL-STD-810G plus the IEC specs below (IEC 60068-2-27) 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours	Humidity	0 to 95%, non-condensing				
(IEC 60068-2-6) 10–500 Hz, 5 g, Sinusoidal  Shock MIL-STD-810G plus the IEC specs below (IEC 60068-2-27) 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours	Vibration	MIL-STD-810G plus the IEC specs below				
Shock  MIL-STD-810G plus the IEC specs below  (IEC 60068-2-27)  100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI  Designed to meet MIL-STD-461  Altitude  70,000 feet, maximum  Sealing  Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage  9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL  >100,000 hours	(IEC 60068-2-64)	10-500 Hz, 5 g (rms), Broad-band random				
(IEC 60068-2-27)  100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours	(IEC 60068-2-6)	10–500 Hz, 5 g, Sinusoidal				
6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours  MTBF 600-MIL >100,000 hours	Shock	MIL-STD-810G plus the IEC specs below				
EMI / RFI Designed to meet MIL-STD-461  Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours  MTBF 600-MIL >100,000 hours	(IEC 60068-2-27)	6 orientations; 30 g, 11 ms half sine, 18 shocks at				
Altitude 70,000 feet, maximum  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours  MTBF 600-MIL >100,000 hours	FMI / RFI					
Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours  MTBF 600-MIL >100,000 hours	· ·	-				
relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired.  Power Requirements  Voltage 9 - 36 VDC designed to meet MIL-1275/704  Reliability  MTBF 400-MIL >100,000 hours  MTBF 600-MIL >100,000 hours						
Voltage         9 - 36 VDC designed to meet MIL-1275/704           Reliability         MTBF 400-MIL         >100,000 hours           MTBF 600-MIL         >100,000 hours	Scaling	relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom				
Reliability           MTBF 400-MIL         >100,000 hours           MTBF 600-MIL         >100,000 hours	Power Requirements					
MTBF 400-MIL >100,000 hours MTBF 600-MIL >100,000 hours	Voltage	9 - 36 VDC designed to meet MIL-1275/704				
MTBF 600-MIL >100,000 hours	Reliability					
	MTBF 400-MIL	>100,000 hours				
MTBF 1200-MIL >130,000 hours	MTBF 600-MIL	>100,000 hours				
	MTBF 1200-MIL	>130,000 hours				

# **UEIPAC: Technical Specifications**

Computer Interface	UEIPAC xxx series Cubes	UEIPAC xxx-1G series GigE Cubes	RACKtangle Chassis
Primary Ethernet Port	10/100Base-T, RJ-45 connector	10/100/1000Base-T, RJ-45 connector	10/100/1000Base-T, RJ-45 connector
Diagnostic Port	Not applicable	10/100/1000Base-T, RJ-45 connector	10/100/1000Base-T, RJ-45 connector
Other Port functions	Daisy chained single port switch provided	Ports may optionally be bonded/teamed	Ports may optionally be bonded/teamed
Optional Interface	100Base-FX Fiber (single or multi mode)	n/a	n/a
Configuration/Serial Port	RS-232, 9-pin "D"	RS-232, 9-pin "D"	RS-232, 9-pin "D"
USB Port	not supported	USB 2.0 fully supported	USB 2.0 fully supported
Synchronization Options	DNA-SYNC series cables/boards provide system clock or trigger synchronization     DNA-IRIG-650 for IRIG and GPS synchronization     NTP using standard Linux functionality	1. DNA-SYNC-1G series cables and boards provide both clock and trigger synchronization signals 2. DNA-IRIG-650 for IRIG and GPS synchronization 3. IEEE-1588 synchronization, requires use of RT Linux 4.4.115 kernel	1. DNA-SYNC-1G series cables and boards provide both clock and triggersynchronization signals 2. DNA-IRIG-650 for IRIG and GPS synchronization 3. IEEE-1588 synchronization, requires use of RT Linux 4.4.115 kernel
I/O Board Support			
Series supported	All DNA-series boards	All DNA-series boards	All DNR-series boards (DNF for FLATrack)
Software / Operating System			
Embedded OS	Linux; kernel 4.9.51	Linux; kernel 4.4.115 or VxWorks 6.9.x	Linux; kernel 4.4.115 or VxWorks 6.9.x
Real-time support	Xenomai 3.05	RTLinux kernel 4.4.115 or Xenomai 3.05 with 4.9.51 or VxWorks	RTLinux kernel 4.4.115 or Xenomai 3.05 with 4.9.51 or VxWorks
Development Language	C/C++, C++11/14/17, Eclipse IDE support	C/C++, C++11/14/17, Eclipse IDE support	C/C++, C++11/14/17, Eclipse IDE support
Development Environments	Linux PC or Cygwin Windows environment	Linux PC or Cygwin Windows environment	Linux PC or Cygwin Windows environment
EPICS CAS interface	Yes	Yes	Yes
SNMP Library	Yes	Yes	Yes
Processor/system			
CPU	Freescale MPC5200, 400 MHz, 32-bit	Freescale 8347 or 8347E, 400 MHz, 32-bit	Freescale 8347 or 8347E, 400 MHz, 32-bit
RAM Memory	128 MB, 100 MB available to user applications	128 MB standard/256 MB optional 100 MB/228 MB available to user applications	128 MB standard/256 MB optional 100 MB/228 MB available to user applications
FLASH memory	4 MB (0 MB available for user applications)	32 MB standard/128 MB optional 16 MB/112 MB available for user applications	32 MB standard/128 MB optional 16 MB/112 MB available for user applications
Solid-State hard drive	Not available	Optional 8, 16, or 32 GByte drives available	Optional 8, 16, or 32 GByte drives available
SD card interface*	SD cards up to 32 GB (8 GByte included)	SD cards up to 32 GByte (8 GByte included)	SD cards up to 32 GByte (8 GByte included)
USB drive interface	n/a	Standard USB 2.0 port	Standard USB 2.0 port
Physical Dimensions			
1 I/O slot		UEIPAC 100-1G: 4.1" W x 4.0" D x 2.7" H	
3 I/O slots	UEIPAC 300: 4.1" W x 4.0" D x 4.0" H	UEIPAC 300-1G: 4.1" W x 5.0" D x 4.0" H	n/a
4 I/O slots			UEIPAC 400F: 16" W x 7.8" D x 1.75" H (Std 1U)
6 I/O slots	UEIPAC 600: 4.1" W x 4.0" D x 5.8" H	UEIPAC 600-1G: 4.1" W x 5.0" D x 5.8" H	UEIPAC 600R: 10.5" W x 5.25" D x 6.2" H
7 I/O slots	UEIPAC 700: 4.1" W x 4.0" D x 6.6" H	UEIPAC 700-1G: 4.1" W x 5.0" D x 6.6" H	
12 I/O slots	n/a	n/a	UEIPAC 1200R: 17.5" W 5.25" D x 6.2" H (Std 3U)
Environmental			
Electrical Isolation	350 Vrms	350 Vrms	350 Vrms
Temperature (Operating/storage)	-40 °C to 85 °C/-40 °C to 100 °C	-40 °C to 70 °C/-40 °C to 85°C	-40 °C to 70 °C /-40 °C to 85°C
Humidity	0 to 95%, non-condensing	0 to 95%, non-condensing	0 to 95%, non-condensing
Vibration		<u>,</u>	
(IEC 60068-2-64)	10–500 Hz, 5 g (rms), Broad-band random	10–500 Hz, 3 g (rms), Broad-band random	10–500 Hz, 3 g (rms), Broad-band random
(IEC 60068-2-6)	10–500 Hz, 5 g, Sinusoidal	10–500 Hz, 3 g, Sinusoidal	10–500 Hz, 3 g, Sinusoidal
Shock			
(IEC 60068-2-27)	100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations	50 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations	5 g, 3 ms half sine, 18 shocks at 6 orientations; 3 g, 11 ms half sine, 18 shocks at 6 orientations
Altitude	70,000 feet (special version to 120,000')	70,000 feet, maximum	70,000 feet, maximum
Power Requirements			
Voltage	9–36 VDC (115/220 VAC adaptor included)	9–36 VDC (115/220 VAC adaptor included)	99–36 VDC (115/220 VAC adaptor included)
Power	3.5 W (not including I/O boards)	7 W (not including I/O boards)	10 W (not including I/O boards)
Reliability			
MTBF	>300,000 hours	>160,000 hours	>130,000/160,000 hours DNR-12/DNR-6

<sup>\*</sup> SD and uSD cards are not available on MIL and BRICK chassis.

#### **Extended Features:**

#### Easy to configure and deploy

- Standard Linux operating system (VxWorks Available)
- Eclipse IDE support
- IOT ready with pre-installed MQTT support
- Supports DDS packages including ZeroMQ, OpenSplice and CoreDX
- Xenomai RTOS support
- EPICS CAS provided
- Web server
- Web Browser (Web Socket) interface included
- FTP server included
- Over 90 different I/O boards available
- Built-in signal conditioning
- Optional 8 or 16 GB Solid-State hard drives
- Standard SD Card file interface
- Flange kit for mounting to wall/flat surface
- DIN rail and Rack Mount kits
- Standard "Off-the-shelf" products and delivery

#### **Flexible Connectivity**

- 100Base-T or GigE with Cat-5 cable
- RS-232 Interface
- 10/100Base-FX Fiber interface available
- Supports Wi-Fi/GSM/Cell networks

#### **Rugged and Industrial**

- 100Base-T Cubes operation tested from -40  $^{\circ}$ C to 85  $^{\circ}$ C
- $\bullet$  RACKS and GigE Cubes operation tested from -40  $^{\circ}\text{C}$  to 70  $^{\circ}\text{C}$
- 100Base-T Cubes Vibration tested to 5 g
- RACKs and GigE Cubes Vibration tested to 3 g
- Shock tested to 100 g (operating)
- 100Base-T Cubes Operation to 120,000 feet (special version Cube)
- 100Base-T Cubes radiation tested for space applications

#### **Compact Size and High Channel Density**

 Analog Inputs: up to 175/300 channels per Cube/RACKtangle

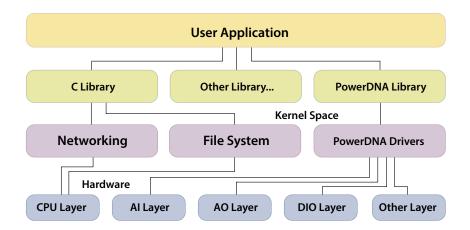
- ICP/IEPE: up to 28/48 channels per Cube/RACKtangle
- Analog Outputs: up to 224/384 channels per Cube/RACKtangle
- Digital I/O: up to 336/576 DIO per Cube/ RACKtangle
- ARINC 429: up to 112/192 channels per Cube/RACKtangle
- Counter/Timer: up to 56/96 counter channels per Cube/RACKtangle
- CAN-bus: up to 28/48 ports per Cube/RACKtangle
- RVDT/LVDT: up to 28/48 channels per Cube/RACKtangle
- RS-232/422/485: up to 56/96 ports per Cube/RACKtangle
- Synchro: up to 28/48 channels per Cube/RACKtangle
- MIL-1553: up to 14/24 redundant ports per Cube/RACKtangle

## **Typical Applications:**

- Embedded Controller
- Hardware-in-the-loop controller
- · Unmanned vehicle controller
- Wind energy and turbine controller
- Smart, Flexible data loggers
- Slaved controller with fail-safe local control and/or shut-down if communication is lost
- HVAC / Environmental controller
- Modern replacement for obsolete VME systems
- Solar Energy system controller
- Machine Health Monitor
- DUT simulator
- · In-vehicle test systems

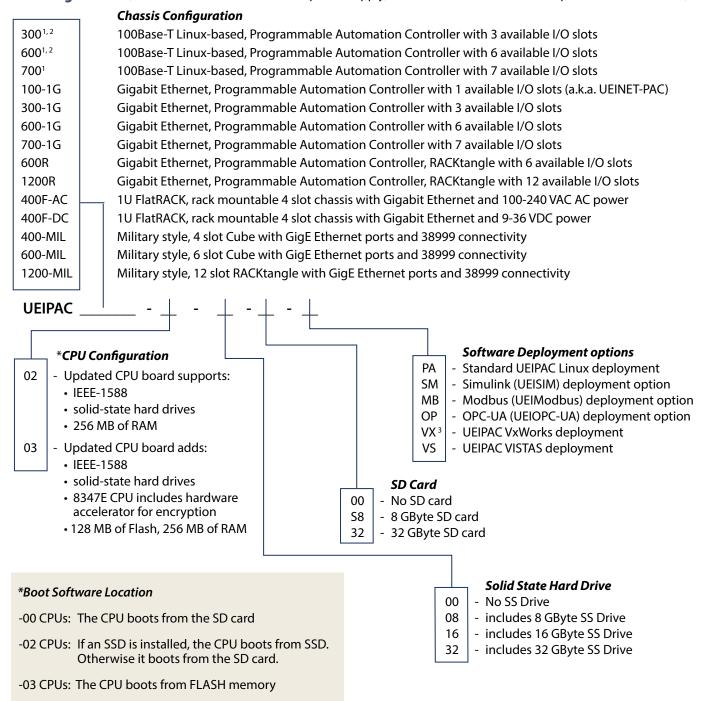
- Avionics simulator
- Single and multiple PID loop controller
- · Rugged and remote DAQ

## **System Block Diagram:**



Please see ordering guide on the following page.

## **Ordering Guide:** (All chassis include: Universal AC power supply, Serial and Ethernet cables and pre-installed Linux OS.)



For example, a 3-slot GigE Cube with 8347E encryption, an 8 GB SS Drive, no SD card in standard PAC mode would be:

#### UEIPAC 300-1G - 03 - 08 - 00 - PA

- <sup>1</sup> There are no CPU or Solid State Drive options available on the UEIPAC 300, 600 and 700.
- <sup>2</sup>The UEPAC 300/600 are available with 100Base-FX fiber connections or a DB-15 power connector. Contact UEI for details.
- \*VxWorks is currently not supported on option "03" CPUs. Please contact UEI if your application needs this capability.
- \*\*SD and uSD cards are not available on MIL and BRICK chassis.

Software including SDK and Board Support Packages (Only one toolkit is required, regardless of the number of UEIPACs deployed)			
Part Number	Description		
<u>UEIPAC VxW BSP</u> (Software Only)	VxWorks Board Support Package (BSP) allows you to program your UEIPAC applications in VxWorks		
<u>UEIPAC-Linux TK</u> (Software Only)	UEIPAC Linux Programmer's Toolkit.		
Extended Warranty	Option to purchase UEI's extended warranty (up to 10 years) is available		